



MJ P-Channel Enhancement Mode Power MOSFET

Description

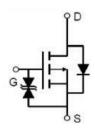
The MJ01P18K uses advanced trench technology and design to provide excellent R_{DS(ON)} with low gate charge. It can be used in a wide variety of applications. It is ESD protested.

General Features

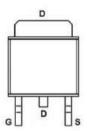
- $ightharpoonup V_{DS}$ =-100V,I_D =-18A $R_{DS(ON)}$ <100mΩ @ V_{GS}=-10V (Typ:85mΩ) $R_{DS(ON)}$ <120mΩ @ V_{GS}=-10V (Typ:95mΩ)
- Super high dense cell design
- ◆ Advanced trench process technology
- ♦ Reliable and rugged
- ◆ High density celldesign for ultra low on-resistance

Application

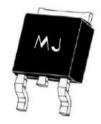
- Power management in notebook computer
- ◆ Portable equipment and battery powered systems







Marking and pin assignment



TO-252 top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ01P18K	MJ01P18K	TO-252-2L	ii ii	-	2

Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	-100	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	-18	А
Drain Current-Continuous(Tc =100°C)	ID(100°C)	-12	А
Pulsed Drain Current	IDM	-100	А
Maximum Power Dissipation	Po	70	W
Single pulse avalanche energy (Note 5)	Eas	170	mJ
Derating factor		0.47	W/°C
Operating Junction and Storage Temperature Range	Тл ,Тѕтс	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	2.14	°C/W
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Electrical Characteristics (Tc =25°Cunless otherwise noted)

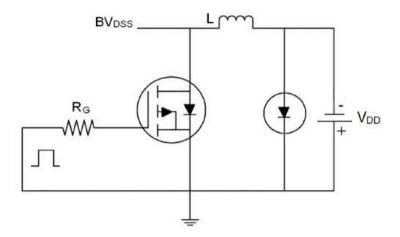
Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics	·						
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =-250μA	-100	-	-	V	
Zero Gate Voltage Drain Current	Ipss	V _{DS} =-100V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±20	μA	
On Characteristics (Note 3)	1						
Gate Threshold Voltage	VGS(th)	V _{DS} =V _{GS} ,I _D =-250μA	-1	-1.9	-3	V	
Decision Company Co. Olada Decision		Vgs=-10V, ID=-16A	-	85	100	mΩ	
Drain-Source On-State Resistance	Rds(on)	Vgs=-4.5V, Ip=-16A		95	120	mΩ	
Forward Transconductance	grs	V _{DS} =-50V,I _D =-10A	5	-	-	S	
Dynamic Characteristics (Note 4)							
Input Capacitance	Clss		-	3810	-	PF	
Output Capacitance	Coss	V _{DS} =-50V,V _{GS} =0V, F=1.0MHz	-	129	-	PF	
Reverse Transfer Capacitance	Crss	-	-	125	-	PF	
Switching Characteristics (Note 4)	'						
Turn-on Delay Time	t _{d(on)}		-	16	-	nS	
Turn-on Rise Time	tr	V _{DD} =-50V,I _D =-16A	-	73	-	nS	
Turn-Off Delay Time	td(off)	V _{GS} =-10V,R _{GEN} =9.1Ω	-	34	-	nS	
Turn-Off Fall Time	tf		-	57	-	nS	
Total Gate Charge	Qg		-	70	-	nC	
Gate-Source Charge	Qgs	V _{DS} =-50V,I _D =-16A V _{GS} =-10V	-	12.5	-	nC	
Gate-Drain Charge	Q _{gd}	-	-	15.5	-	nC	
Drain-Source Diode Characteristics						l	
Diode Forward Voltage (Note 3)	VsD	V _{GS} =0V,I _S =-10A	-	-	-1.2	V	
Diode Forward Current (Note 2)	Is		_	-	-18	А	
Reverse Recovery Time	trr	TJ=25°C, IF=-16A	_	88.3	-	nS	
Reverse Recovery Charge	Qrr	di/dt=100A/µs (Note 3)	-	65.9	-	nC	
Forward Turn-On Time	ton	Intrinsic turn-on time is negligible(turn-on is dominated by LS					

Notes:

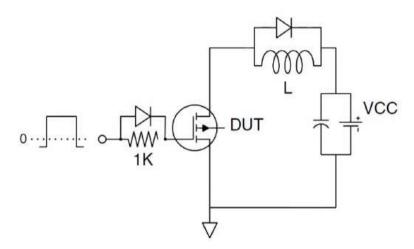
- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, $t \le 10$ sec.
- ③ Pulse Test: Pulse Width ≤ 300 μ s, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production
- \odot EAS condition: Tj=25°C,VDD=-50V,VG=-10V,L=0.5mH,Rg=25 Ω



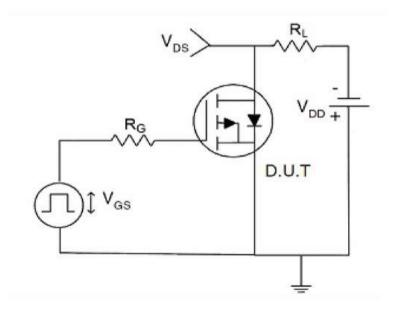
Test circuit



Eas test Circuit



Gate charge test Circuit

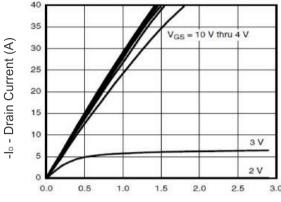


Switch Time Test Circuit

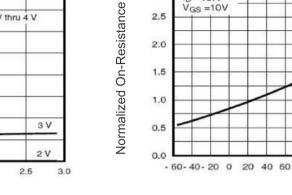
80 100 120 140 160 180



Typical Electrical and Thermal Characteristics (Curves)



-Vds Drain-Source Voltage (V) Figure 1 Output Characteristics



3.0

2.5

2.0

I_D =10 A V_{GS} =10 V

T_J -Junction Temperature(°C) Figure 4 Rdson-Junction Temperature

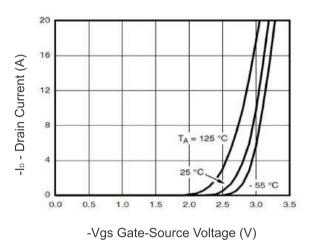
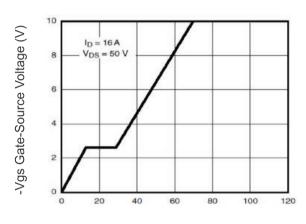


Figure 2 Transfer Characteristics



Qg Gate Charge (nC) Figure 5 Gate Charge

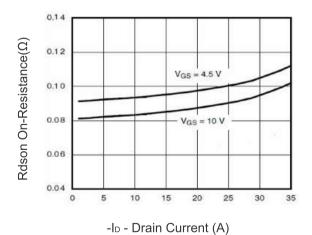


Figure 3 Rdson- Drain Current

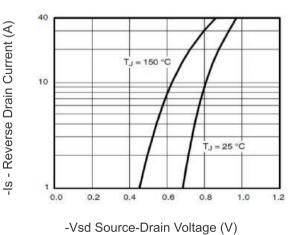
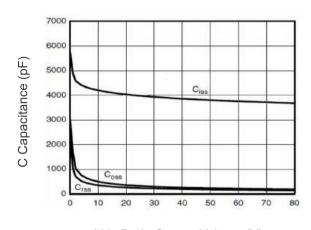


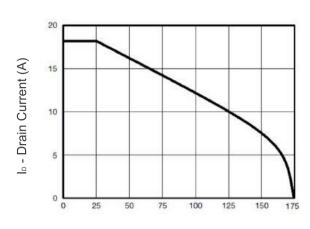
Figure 6 Source- Drain Diode Forward





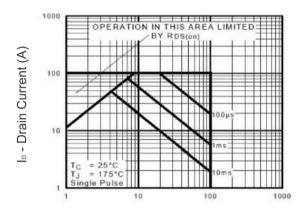
-Vds Drain-Source Voltage (V)

Figure 7 Capacitance vs Vds



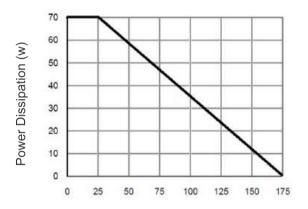
Tc Case Temperature(°C)

Figure 9 Drain Current vs Case Temperature



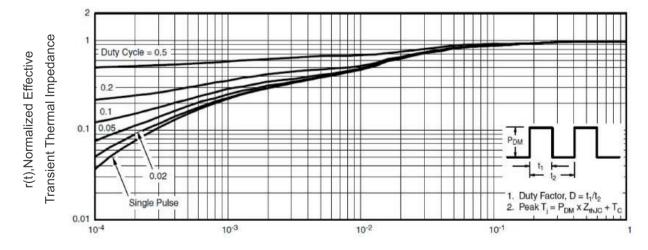
Vds Drain-Source Voltage (V)

Figure 8 Safe Operation Area



Tc-Case Temperature(°C)

Figure 10 Power De-rating



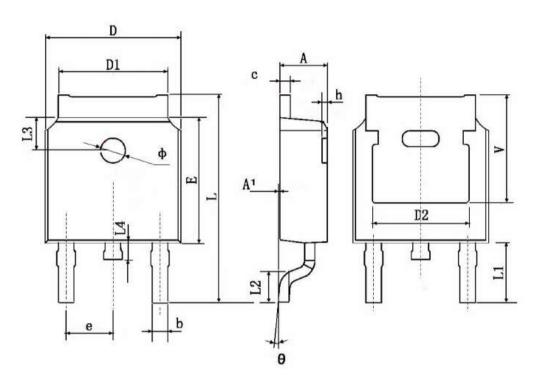
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-252 Package Information

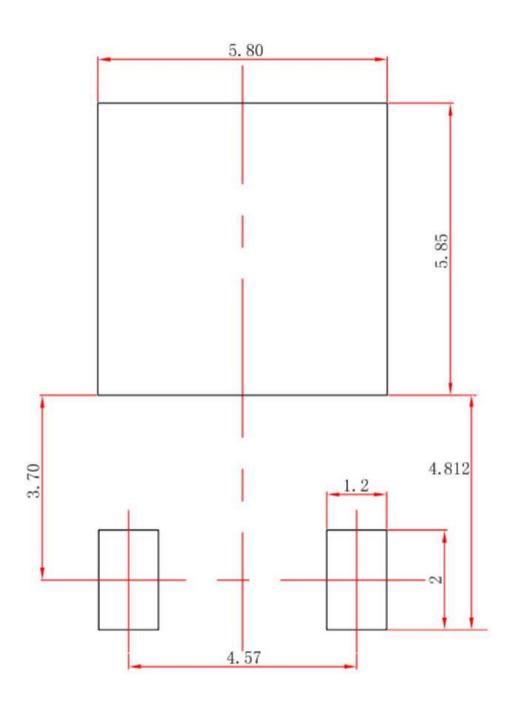


O	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.8	30 TYP.	0.190	TYP.	
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900	TYP.	0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600	TYP.	0.063	TYP.	
L4	0.600	1.000	0.024 0.0		
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0.	8°	
h	0.000	0.300	0.000	0.012	
V	5.350 TYP.		0.211	TYP.	





焊盘



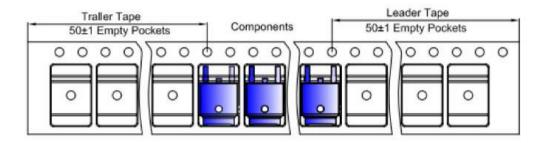
技术要求

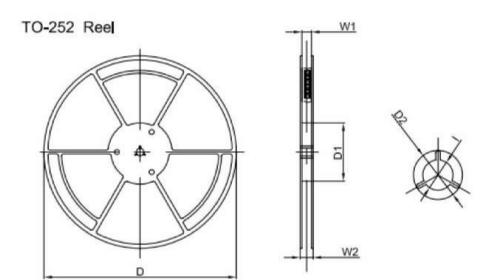
1.塑封体尺寸6.60X6.10 2.未注公差为: ±0.05 3.所有单位为: mm





TO-252 Tape Leader and Trailer





Dimensions are in millimeter							
Reel Option	D	D1	D2	W1	W2	l E	
13"Dia	330.00	100.00	Ø21.00	16.40	21.00	Ø13.00	
Tolerance	+/-2	+/-1	+/-1	+/-1	+/-1	+/-1	

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
2,500 pcs	13inch	2,500 pcs	340×336×29	25,000 pcs	353×346×365	14.04





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